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Appıı	cation Dai	a Sheet 37	CFR 1.	Applica	ation Numbe	er			
Title of	finvention	SEALANT EPO	DXY-RES	IN MOLDING	MATERIAL, A	ND ELE	CTRONI	C COMPONENT DEVICE	
bibliogra This doo	phic data arrang cument may be	jed in a format spe	cified by the nically and	e United States submitted to t	Patent and Tra	demark C	office as o	omitted. The following form contains utlined in 37 CFR 1.76. g the Electronic Filing System (EF	
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Mailing	g Address o	f Applicant:							
Addre	ss 1	c/o Hitac	hi Chemic	al Co., Ltd.,					
Addre	ss 2	Research	n & Develo	opment Cente	r, 48, Wadai,				
City	Tsukub	a-shi, Ibrakai			Stat	e/Provir	nce		
Postal	Code	300-4247	7		Country	JP			
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Applica	tion Da	ta Si	heet 37	CER	1 76	Attorne	ey Docket	Number	MIYC	SH0008	
Дриос	, , p					Application Number					
Title of In	vention	SEA	ALANT EP	OXY-F	RESIN	MOLDING I	MATERIAL	, AND ELI	ECTRON	IC COMPONENT DEVICE	
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Mailing A	ddress o	of App	plicant:								
Address	Address 1 c/o Hitachi Chemical Co., Ltd.,										
Address	2		Shimod	ate Wo	rks, 17	72-1, Oaza	Kanakubo				
City	Yuki-sh	ni, Ibar	aki				St	ate/Prov	ince		
Postal Co	ode		307-001	5			Country	ri JP		•	
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Applican	t Authori	ty 💿	Inventor	Ore	egal Re	epresentativ	e under 3	5 U.S.C. 1	17	Party of Interest under 35 U.S	.C. 118
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Citizensh	nip under	37 C	FR 1.41(	b) i	JP						
Mailing A	Address o	of App	olicant:								
Address	1		c/o Hita	chi Che	emical (	Co., Ltd.,					
Address	2		Shimod	ate Wo	rks, 17	72-1, Oaza	Kanakubo				
City	Yuki-sh	ni, Ibar	aki				St	ate/Prov	ince		
Postal Co	ode		307-001	5			Country	i JP			
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F	Ryouichi					lkezawa				wa	
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Citizensh	nip under	37 C	FR 1.41(	b) i	JP						
Mailing A	Address o	of Ap	plicant:								
Address	1		c/o Hita	chi Che	mical (	Co., Ltd.,					
Address	2		Researc	h & De	evelopn	nent Centei	<del></del> ,—			T	
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Application Da	ta She	et 37 CFR 1.76	Attorney Docke	et Number	MIYOS	H0008			
Application Be	ita Onc	CC 07 C1 K 1:70	Application Number						
Title of Invention	SEALA	ANT EPOXY-RESIN M	OLDING MATERIA	AL, AND ELEC	CTRONIC	COMPONEN	NT DEV	ICE.	
Email Address		gands@szipl.com				Add Ema	iil	Remove	e Email
Application Ir	form	ation:							
Title of the Invent	io <b>n</b>	SEALANT EPOXY-	RESIN MOLDING	MATERIAL, A	ND ELEC	TRONIC CO	MPON	ENT DEV	ICE
Attorney Docket I	Number	MIYOSH0008		Small Ent	it <b>y S</b> tatu	s Claimed			
Application Type		Nonprovisional							
Subject Matter		Utility							
Suggested Class	(if any)			Sub Class	s (if any)				
Suggested Techn	ology C	enter (if any)							
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## **Domestic Priority Information:**

This section allows for the applicant to claim benefit under 35 U.S.C. 119(e), 120, 121, or 365(c). Providing this information in the application data sheet constitutes the specific reference required by 35 U.S.C. 119(e) or 120, and 37 CFR 1.78(a)(2) or CFR 1.78(a) (4), and need not otherwise be made part of the specification.

Prior Application Status			Remove				
Application Number	Continuity Type	Prior Application Number	Filing Date (YYYY-MM-DD)				
	a 371 of international	PCT/JP2005/003592	2005-03-03				
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Application Da	ta Sheet 37 CFR 1.76	Attorney Docket Number	MIYOSH0008
Application Bo	ita onceror or it i.ro	Application Number	
Title of Invention	SEALANT EPOXY-RESIN M	OLDING MATERIAL, AND ELEC	CTRONIC COMPONENT DEVICE

This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes the claim for priority as required by 35 U.S.C. 119(b) and 37 CFR 1.55(a).

		Re	nove				
Application Number	Country i	Parent Filing Date (YYYY-MM-DD)	Priority Claimed				
2004-059106	JP	2004-03-03	● Yes ○ No				
Additional Foreign Priority Data may be generated within this form by selecting the Add button.							

### **Assignee Information:**

Providing this information in the application data sheet does not substitute for compliance with any requirement of part 3 of Title 37 of the CFR to have an assignment recorded in the Office.								
Assignee 1			Remove					
If the Assignee is an Organization check here.								
Organization Name Hitachi Chemical Co., Ltd.								
Mailing Address Information:								
Address 1	1-1, Nishishinjuku 2-chome,							
Address 2								
City	Shinjuku-ku, Tokyo	State/Province						
Country   JP		Postal Code	163-0449					
Phone Number		Fax Number						
Email Address			•					
Additional Assignee Data may be generated within this form by selecting the Add button.								

# Signature:

	A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please see 37 CFR 1.4(d) for the form of the signature.									
Signature	/Joerg-Uwe Szipl/	Date (YYYY-MM-DD)	2006-09-01							
First Name Joerg-Uwe Last Name Szipl		Szipl	Registration Number	31799						

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 23 minutes to complete, including gathering, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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- 7. A record from this system of records may be disclosed, as a routine use, to the Administrator, General Services, or his/her designee, during an inspection of records conducted by GSA as part of that agency's responsibility to recommend improvements in records management practices and programs, under authority of 44 U.S.C. 2904 and 2906. Such disclosure shall be made in accordance with the GSA regulations governing inspection of records for this purpose, and any other relevant (i.e., GSA or Commerce) directive. Such disclosure shall not be used to make determinations about individuals.
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